P. La Torraca¹, Y. Ricci¹, A. Falco², P. Lugli², L. Larcher¹ ¹Department of Sciences and Methods for Engineering, University of Modena and Reggio Emilia, Italy ²Faculty of Science and Technology, Free University of Bozen-Bolzano, Italy paolo.latorraca@unimore.it

The recent advancements in the synthesis of solution-processed nanomaterials and the development of facile printing techniques allow the fabrication of nanostructures with unprecedented physical properties. The spray-coating deposition of solution-processed metallic nanowires enables for instance the fabrication of nanostructured layers, characterized by a low electrical resistance and an extremely low heat capacity [1]-[4], recognized as a promising solution for the development of efficient thermoacoustic (TA) loudspeakers [5]-[7]. The TA loudspeaker technology have long been studied but the models reported in literature are not fully adequate for the model-driven development of the technology, either lacking of a description of the device thermal behavior [8], [9], not accounting for the 3D geometry of the thermal and acoustic fields in air [10], [11], or neglecting the contribution of the heat losses due to convection and radiation [12]. In this work we present a multiphysics model of the TA loudspeaker transduction, overcoming the above limitations by considering the full electroacoustic transduction as a sequence of two atomic processes: an electro-thermal transduction, describing all the involved thermal processes, and a thermo-acoustic transduction, accounting for the interaction between the thermal and acoustic fields. The model very accurately reproduces the response of nanostructured TA loudspeakers, providing a useful tool for further developing the technology.

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